508244006 11/22/2023

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT8291196

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
APPLIED MATERIALS SINGAPORE TECHNOLOGY PTE. LTD.	11/21/2023

RECEIVING PARTY DATA

Name:	Applied Materials, Inc.	
Street Address:	3050 Bowers Avenue	
City:	Santa Clara	
State/Country:	CALIFORNIA	
Postal Code:	ostal Code: 95054	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	17009851	

CORRESPONDENCE DATA

Fax Number: (732)935-7122

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 732-935-7100

Correspondent Name: MOSER TABOADA/ALAN TABOADA

Address Line 1: 1040 BROAD STREET

Address Line 2: SUITE 103

Address Line 4: SHREWSBURY, NEW JERSEY 07702

ATTORNEY DOCKET NUMBER:	44017310US1	
NAME OF SUBMITTER:	ALAN TABOADA	
SIGNATURE:	/ALAN TABOADA/	
DATE SIGNED:	11/22/2023	

Total Attachments: 3

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PATENT 508244006 REEL: 065645 FRAME: 0910

ASSIGNMENT

WHEREAS, Applied Materials Singapore Technology Pte. Ltd., a company organized

under the laws of Singapore, and having a principal place of business at 8 Upper Changi Road

North, Applied Materials Building, Singapore 506906 (hereinafter referred to as ASSIGNOR),

is the owner of all right, title, and interest in, to, and under the patents and patent applications

identified in the attached **Annex A**, and the inventions disclosed therein.

WHEREAS, Applied Materials, Inc., a corporation organized under the laws of the State

of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, CA 95054,

U.S.A. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title,

and interest in, to, and under the patents and patent applications identified in the attached Annex

A, and the inventions disclosed therein.

NOW, THEREFORE, for good and valuable consideration acknowledged by said

ASSIGNOR to have been received in full from said ASSIGNEE, ASSIGNOR, hereby sells,

assigns, transfers, and conveys to ASSIGNEE or its successor and assigns, the entire right, title

and interest in, to, and under the patents and patent applications identified in the attached Annex

A, and the inventions disclosed therein, and any related patent applications, and all divisions,

renewals, and continuations of any of the foregoing, and all patents which may be granted

thereon and all reissues and extensions thereof; and all applications for industrial property

protection, including, without limitation, all applications for patents, utility models, and designs

which may hereafter be filed for the patents, patent applications, and inventions in any country

or countries other than the countries of the patents and patent applications in **Annex A** together

with the right to file such applications and the right to claim for the same, the priority rights

derived from the patents and patent applications, the International Convention for the Protection

of Industrial Property, or any other international agreement or the domestic laws of the country

in which any such application is filed.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and

Trademarks of the United States, and any official of any country or countries foreign to the

United States, whose duty it is to issue patents or other evidence or forms of industrial property

protection on patents and patent applications as aforesaid, to issue the same to the ASSIGNEE,

its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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PATENT REEL: 065645 FRAME: 0911 ASSIGNOR hereby covenants and agrees that ASSIGNOR has full right to convey the entire interest assigned, and that ASSIGNOR has not executed, and will not execute, any agreement in conflict herewith.

ASSIGNOR hereby further covenants and agrees that ASSIGNOR will communicate to ASSIGNEE, its successor, legal representatives and assigns, any facts known to ASSIGNOR regarding the inventions, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, and foreign applications, make all rightful oaths, and generally aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for the inventions in all countries all at ASSIGNEE'S expense.

IN WITNESS WHEREOF, ASSIGNOR has executed and delivered this instrument to ASSIGNEE on the date indicated below.

Na 21, 2023

Signature(s)

Samuel K. Lee

Typed or printed name(s)

Director

Title(s) of person(s) signing

Applied Materials Singapore Technology Pte. Ltd.
Assignor name

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ANNEX A

Serial Number	Docket Number	Filing Date	Title
17/009,851	44017310US1	Sep 2, 2020	Solid-State Power Amplifiers With Cooling Capabilities

1487249_1

RECORDED: 11/22/2023

PATENT REEL: 065645 FRAME: 0913